

100V 175°C DUAL N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BVDSS	Rds(on) Max	I _D Max T _C = +25°C
100V	$33m\Omega @ V_{GS} = 10V$	25A

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- DC-DC converters
- Motors

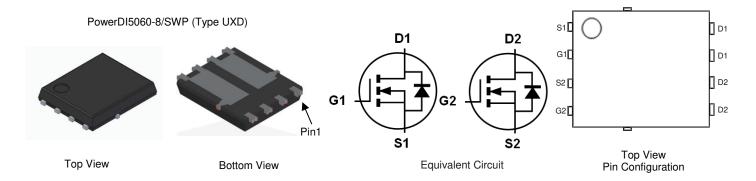
Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Additional Tin-Plated on Sidewall Pads for Optical Solder Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH10H038SPDWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 ³
- Weight: 0.097 grams (Approximate)



Ordering Information (Note 4)

Part Number	Pookogo	Packing		
Part Number	Package	Qty.	Carrier	
DMTH10H038SPDWQ-13	PowerDI5060-8/SWP (Type UXD)	2500	Tape & Reel	

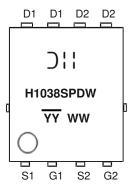
Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

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Marking Information



⊃¦¦ = Manufacturer's Marking H1038SPDW = Product Type Marking Code
YYWW = Date Code Marking YY = Year (ex: 22 = 2022) WW = Week (01 to 53)

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	100	V	
Gate-Source Voltage	V _{GSS}	±20	V	
Continuous Drain Current, $V_{GS} = 10V$ (Note 5) $T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$		lο	25 18	А
Maximum Body Diode Forward Current	Is	25	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	100	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Tc = +25°C)	Ism	100	Α	
Avalanche Current, L = 0.3mH	las	12.5	Α	
Avalanche Energy, L = 0.3mH	Eas	23.4	mJ	

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	55	°C/W	
Total Power Dissipation $T_A = +25^{\circ}C$		PD	2.7	W
Thermal Resistance, Junction to Case (Note 5)	Rejc	3.8	°C/W	
Total Power Dissipation	T _C = +25°C	P _D	39	W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Notes:

- 5. Thermal resistance from junction to solder point (on the exposed drain pin).6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



Electrical Characteristics (@T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	100	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V _{DS} = 80V, V _{GS} = 0V	
Gate-Source Leakage	IGSS	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)	•	•					
Gate Threshold Voltage	V _{GS(TH)}	2	_	4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	25	33	mΩ	$V_{GS} = 10V, I_D = 10A$	
Diode Forward Voltage	V _{SD}	_	0.9	1	V	V _{GS} = 0V, I _S = 10A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	544	_	pF	., 50,4,4, 0,4	
Output Capacitance	Coss	_	181	_	pF	V _{DS} = 50V, V _{GS} = 0V - f = 1MHz	
Reverse Transfer Capacitance	Crss	_	6.0	_	pF	1 – 11011 12	
Gate Resistance	R_g	_	1.2	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (VGS = 4.5V)	Qg	_	4.3	_	nC		
Total Gate Charge (Vgs = 10V)	Qg	_	8.0	_	nC	V _{DS} = 50V, I _D = 7A	
Gate-Source Charge	Q_{gs}	_	1.8	_	nC	VDS = 30V, ID = 7A	
Gate-Drain Charge	Qgd	_	2.4	_	nC		
Turn-On Delay Time	td(on)	_	8.5	_	ns		
Turn-On Rise Time	tr	_	2.7	_	ns	$V_{DS} = 50V$, $I_{D} = 7A$ $V_{GS} = 10V$, $R_{GEN} = 6\Omega$	
Turn-Off Delay Time	t _{D(OFF)}	_	11.9	_	ns		
Turn-Off Fall Time	tF	_	6.2	_	ns		
Reverse Recovery Time	trr	_	33.2	_	ns	I _F = 7A, di/dt = 100A/μs	
Reverse Recovery Charge	Q _{RR}	_	34.3	_	nC		

Notes:

^{7.} Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.



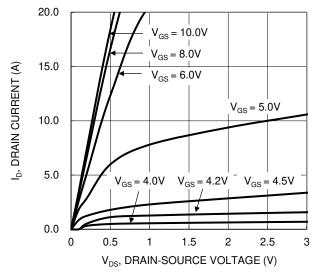


Figure 1. Typical Output Characteristic

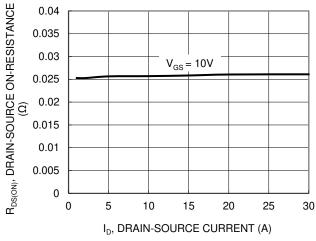


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

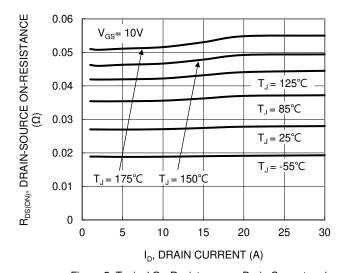


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

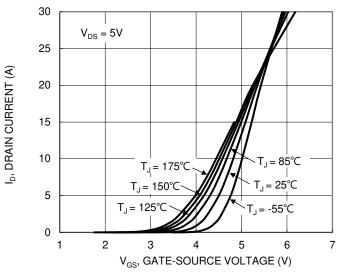


Figure 2. Typical Transfer Characteristic

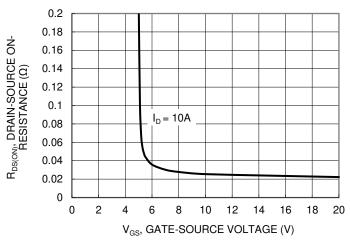


Figure 4. Typical Transfer Characteristic

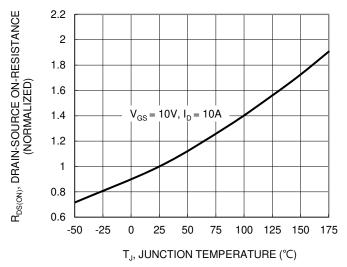
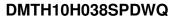


Figure 6. On-Resistance Variation with Junction Temperature





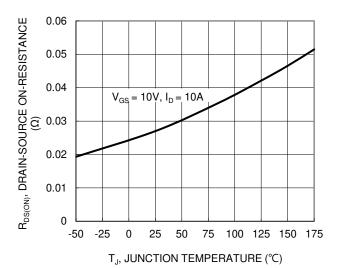


Figure 7. On-Resistance Variation with Junction Temperature

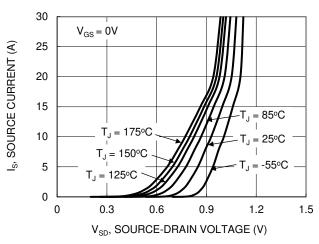


Figure 9. Diode Forward Voltage vs. Current

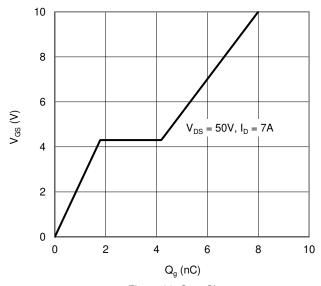


Figure 11. Gate Charge

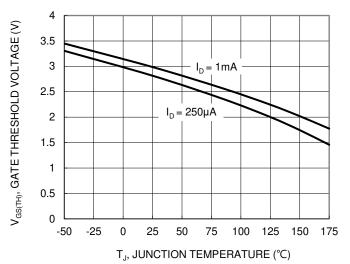


Figure 8. Gate Threshold Variation vs. Junction Temperature

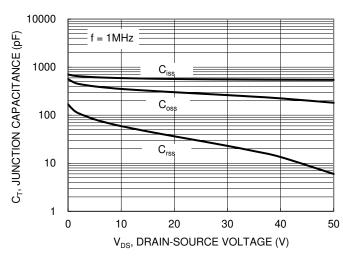


Figure 10. Typical Junction Capacitance

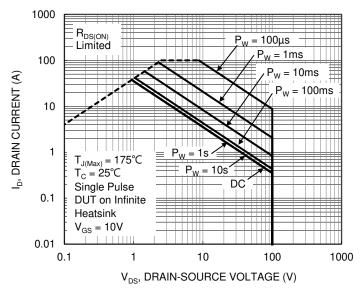


Figure 12. SOA, Safe Operation Area



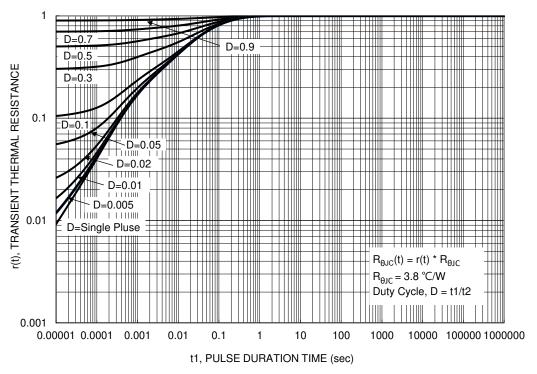


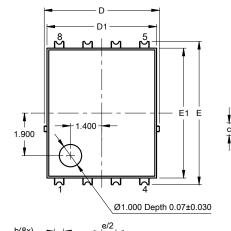
Figure 13. Transient Thermal Resistance

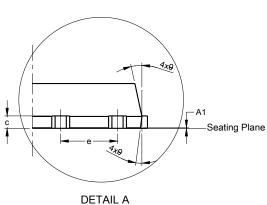


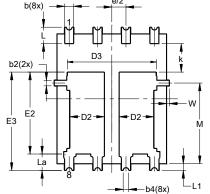
Package Outline Dimensions

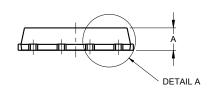
Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UXD)







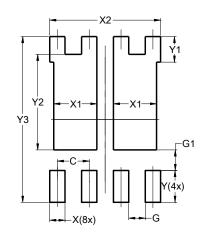


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PowerDI5060-8/SWP (Type UXD)					
Dim	Min	Max	Тур		
	IVIIII				
Α	0.90	1.10	1.00		
A1	0.00	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	().25REF			
С	0.230	0.330	0.277		
D	5	.15 BS0)		
D1	4.70	5.10	4.90		
D2	1.46	1.46 1.66			
D3	3.78	4.18	3.98		
Е	6	.40 BS0			
E1	5.60	6.00	5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1	.27BSC)		
k	1.05				
L	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
М	3.205	4.005	3.605		
W	0.025	0.225	0.125		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UXD)



Dimensions	Value		
פווטופווטוט	(in mm)		
C	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	1.720		
X2	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		
Y3	6.610		



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